IPC ASSOCIATION ELECTRONIC	Material Compo © Copyright 2005. II cs INDUSTRIES® international and Pan	PC, Bannockb	urn, Illinois. A	all rights reserved un	nder both	This docume level parts, t	ent is a declaration	tion of the	substances ses all lowe	within the r level ma	e manufactur terials for w	rer listed it hich the m	em. Note: i	if the item is an as r has engineering	sembly with lowe responsibility.
1752-21.1	1.1 IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mf	g Informat	tion		
Supplie	r Information														
Company name* Company unique ID					1	Unique ID Authority Response Date*					e Date*	te*			
onsemi											2023-06-08				
Contact N	lame	Title - Contact			]	Phone - Contact*					Email - Contact*				
Product-l	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorize	ed Representative*	Title - Representative			]	Phone - Representative*				Email - Representative*					
Product-l	Env-Stewards	Product Envi	oduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item		Number	fumber Mfr Item Name			Effective Date Version Manufacturing Site		ring Site	V	Veight*	UOM	Unit Type		
		STK682-	010-E	Stepping motor dri	iver		2023-06-08		,	VN2		3	900.0	mg	Each
Manufa	cturing Proccess Informat	tion						<u> </u>							
	Terminal Plating / Grid Array Material		erminal Base	rminal Base Alloy J-STD-020 MSI		_ Rating	Peak Process Body Temperatur		re Max T	ime at Peak	Temperatu	ire Numl	ber of Reflow Cyc	les	
	Matte Tin (Sn) - annealed C		CU Alloy	y NA			0	0 C 30			seconds 3				
Comments	3														
or more	information regarding material	composition ]	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others, in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Ceramic Substrate	1155.57	mg	Supplier	Bisphenol A_Epichlorohydrin Polymer	25068-38-6		6.5867	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		43.9117	mg
			В	Nickel (Ni)	7440-02-0		2.08	mg
			Supplier	Acrylic resins	Proprietary Data		0.8089	mg
			Supplier	Copper (Cu)	7440-50-8		41.0227	mg
			Supplier	Barium Sulfate (BaSO4)	7727-43-7		0.6933	mg
			Supplier	Aluminum (Al)	7429-90-5		1060.4666	mg
Chip Parts	18.91	mg	Supplier	Silver (Ag)	7440-22-4		0.0227	mg
			Supplier	Bisphenol A, Epichlorohydrin polymer	25036-25-3, 25068- 38-6		0.0076	mg
			Supplier	Tin (Sn)	7440-31-5		0.4614	mg
			Supplier	Magnesium Monoxide (MgO)	1309-48-4		0.0151	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.034	mg
			Supplier	Ceramic	12013-47-7, 12047- 27-7		11.953	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.9776	mg
			В	Nickel (Ni)	7440-02-0		2.5056	mg
			Supplier	Chromium Trioxide (Cr2O3)	1308-38-9		0.0019	mg
			Supplier	Copper (Cu)	7440-50-8		2.9311	mg
Die	14.56	mg	Supplier	Silicon (Si)	7440-21-3		14.5061	mg
			Supplier	Polyimide	Proprietary Data		0.0539	mg
Lead Frame	479.21	mg	Supplier	Tin (Sn)	7440-31-5		0.2875	mg
			Supplier	Copper (Cu)	7440-50-8		478.9225	mg
Mold Compound-Black	2220.35	mg		Brominated epoxy resin	proprietary data		44.407	mg
			Supplier	Phenolic Resin	Proprietary Data		155.4245	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		44.407	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1554.245	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		421.8665	mg
Plating	0.96	mg	Supplier	Tin (Sn)	7440-31-5		0.5943	mg
			В	Nickel (Ni)	7440-02-0		0.3657	mg
Solder Ball	9.17	mg	Supplier	Silver (Ag)	7440-22-4		0.2558	mg
			Supplier	Tin (Sn)	7440-31-5		8.8619	mg

			В	Antimony (Sb)	7440-36-0	0.0073	mg
			Supplier	Copper (Cu)	7440-50-8	0.0449	mg
Wire Bond	1.27	mg	Supplier	Silicon (Si)	7440-21-3	0.0038	mg
			Supplier	Aluminum (Al)	7429-90-5	1.2662	mg